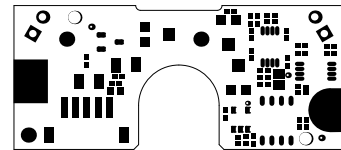
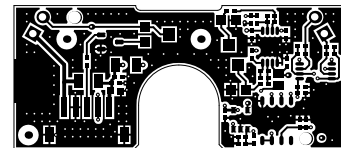


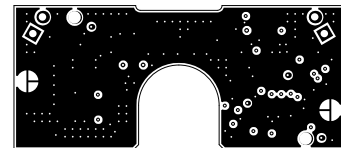
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4043	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00378		
PLOT NAME = Top Overlay	GENERATED : 12/1/2015 3:42:34 PM	TEXAS INSTRUMENTS	



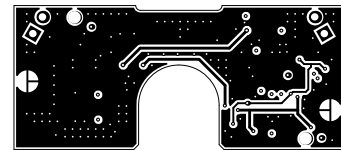
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4043	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00378		
PLOT NAME = Top Solder Mask	GENERATED : 12/1/2015 3:42:35 PM	TEXAS INSTRUMENTS	



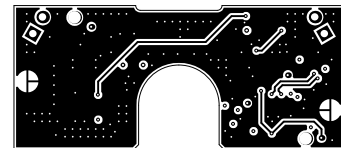
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4043	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00378		
PLOT NAME = Top Layer	GENERATED : 12/1/2015 3:42:36 PM	TEXAS INSTRUMENTS	



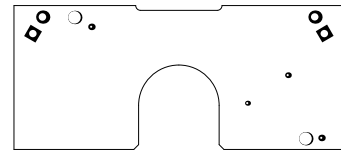
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4043	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Signal Layer 1	TID #: TIDA-00378		
PLOT NAME = Signal Layer 1	GENERATED : 12/1/2015 3:42:37 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4043	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Signal Layer 2	TID #: TIDA-00378		
PLOT NAME = Signal Layer 2	GENERATED : 12/1/2015 3:42:37 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4043	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00378		
PLOT NAME = Bottom Layer	GENERATED : 12/1/2015 3:42:38 PM	TEXAS INSTRUMENTS	

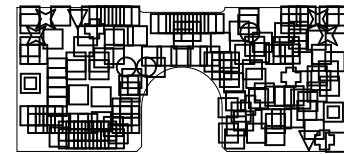


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4043	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00378		
PLOT NAME = Bottom Solder Mask	GENERATED : 12/1/2015 3:42:39 PM	TEXAS INSTRUMENTS	

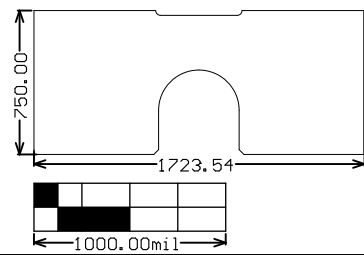


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4043	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00378		
PLOT NAME = Bottom Overlay	GENERATED : 12/1/2015 3:42:39 PM	TEXAS INSTRUMENTS	

Symbol	Quantity	Finished Hole Size	Plated	Hole Type
▽	2	66.00mil (1.676mm)	NPTH	Round
■	2	98.00mil (2.489mm)	NPTH	Round
□	150	10.00mil (0.254mm)	PTH	Round
⊗	4	12.00mil (0.305mm)	PTH	Round
○	3	13.00mil (0.330mm)	PTH	Round
⊗	4	39.37mil (1.000mm)	PTH	Round
	165 Total			



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4043	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00378		
PLOT NAME = Drill Drawing	GENERATED : 12/1/2015	3:42:40 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4043	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00378		
PLOT NAME = Board Dimensions	GENERATED : 12/1/2015 3:42:41 PM	TEXAS INSTRUMENTS	

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